TERMINATION CHIP 10 WATT



EN 13-3453

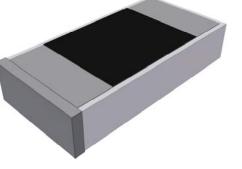
DATA SHEET PART SERIES: 82-3001

FEATURES

Wide Band Operation High Power **Direct Attached** Low VSWR Easy Installation

APPLICATIONS

Mobile Networks Broadcast **High Power Amplifiers** Isolators Military Instrumentation



Dwg 82-3001

GENERAL DESCRIPTION

EMC Technology offers the widest selection of chip terminations worldwide. Chip components are offered in both thick and thin film resistive material and available in Alumina, Aluminum Nitride, Beryllium Oxide and CVD Diamond.

ORDERING INFORMATION

Part Identifier: 82-3001

SPECIFICATIONS

1.0 ELECTRICAL

ohms
C - 4.0 GHz
5:1 Max
Watts @ 100°C heat sink, derated linearly to zero power and 150°C
0 Watts (based on 10us pulse width and 1% duty cycle)
Ω ±5%

2.0 ENVIRONMENTAL

Operating Temperature: Non-operating Temperature: Temperature Coefficient:

3.0 MARKING

Unit Marking:

No Marking

-55°C to +150°C

-65°C to +150°C +/-200 PPM / °C max

4.0 QUALITY ASSURANCE

Visual and Mechanical Inspection: Per 824W107 100% DC Resistance Check DC Resistance Check: Data Retention: Standard

5.0 PACKAGING

Standard Packaging:

Tape and Reel

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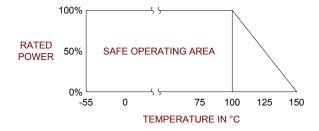
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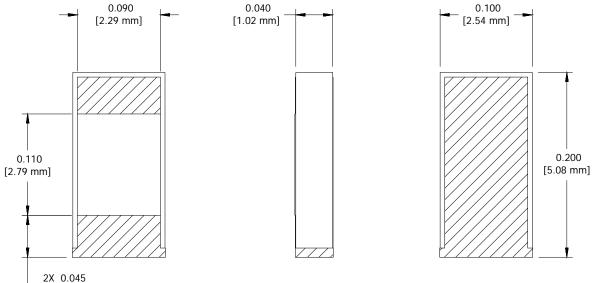
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Technolo

6.0 MECHANICAL

Substrate Material: Resistive Film: Terminal Material: Metric Dimensions: Beryllium Oxide Nichrome Tin/Lead Provided for reference only





_ 2X 0.045 [1.14 mm]

Unless Otherwise Specified: TOLERANCE: X.XX = ± 0.02 X.XXX = ± 0.010